

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Soo-geun Lee, et al.

Examiner: Nguyen, H.

Serial No.:

10/081,661

Group Art Unit: 2812

Filing Date:

February 22, 2002

Title:

METHOD OF MANUFACTURING INTERCONNECTION LINE IN

SEMICONDUCTOR DEVICE

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8

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Commissioner for Patents

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AMENDMENT A

Sir:

The following is in response to the Office Action dated October 15, 2003, and is filed within the shortened statutory period of three months.

Please amend the application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.